- **Members of the Texas Instruments Widebus™ Family**
- **Support the VME64 ETL Specification**
- **Reduced, TTL-Compatible, Input Threshold Range**
- **High-Drive Outputs (I_{OH} = –60 mA, I_{OL} = 90 mA) Support 25-Ω Incident-Wave Switching**
- **V_{CC}BIAS Pin Minimizes Signal Distortion During Live Insertion**
- **Internal Pullup Resistor on $\overline{OE}$ Keeps Outputs in High-Impedance State During Power Up or Power Down**
- **Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise**
- **Equivalent 25-Ω Series Damping Resistor on B Port**
- **Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors**

SN54ABTE16245 . . . WD PACKAGE
SN74ABTE16245 . . . DGG OR DL PACKAGE
(TOP VIEW)

1DIR	1	48	V_{CC}BIAS
1B1	2	47	1A1
2B1	3	46	2A1
GND	4	45	GND
1B2	5	44	1A2
2B2	6	43	2A2
V_{CC}	7	42	V_{CC}
1B3	8	41	1A3
2B3	9	40	2A3
GND	10	39	GND
1B4	11	38	1A4
2B4	12	37	2A4
1B5	13	36	1A5
2B5	14	35	2A5
GND	15	34	GND
1B6	16	33	1A6
2B6	17	32	2A6
V_{CC}	18	31	V_{CC}
1B7	19	30	1A7
2B7	20	29	2A7
GND	21	28	GND
1B8	22	27	1A8
2B8	23	26	2A8
2DIR	24	25	$\overline{OE}$

description

The ’ABTE16245 devices are 16-bit (dual-octal) noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements. These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ($\overline{OE}$) input can be used to disable the device so that the buses are effectively isolated. When $\overline{OE}$ is low, the device is active.

The B port has an equivalent 25-Ω series output resistor to reduce ringing. Active bus-hold inputs also are on the B port to hold unused or floating inputs at a valid logic level.

The A port provides for the precharging of the outputs via V_{CC}BIAS, which establishes a voltage between 1.3 V and 1.7 V when V_{CC} is not connected.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

ORDERING INFORMATION

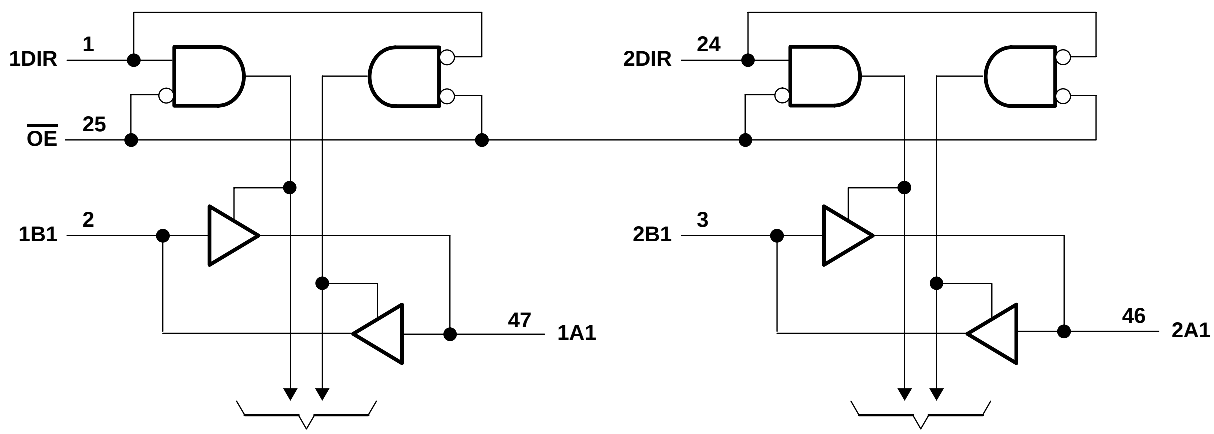
T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SSOP – DL	Tube	SN74ABTE16245DL	ABTE16245
		Tape and reel	SN74ABTE16245DLR	
	TSSOP – DGG	Tape and reel	SN74ABTE16245DGGR	ABTE16245
–55°C to 125°C	CFP – WD	Tube	SNJ54ABTE16245WD	SNJ54ABTE16245WD

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE
(each 8-bit section)

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	A data to B bus
L	H	B data to A bus
H	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC} and V_{CC}BIAS . . . . –0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1) . . . . –0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O . . . . –0.5 V to 5.5 V
Current into any output in the low state, I_O . . . . 128 mA
Input clamp current, I_{IK} (V_I < 0) . . . . –18 mA
Output clamp current, I_{OK} (V_O < 0) . . . . –50 mA
Package thermal impedance, θ_{JA} (see Note 2): DGG package . . . . 70°C/W
DL package . . . . 63°C/W
Storage temperature range, T_{stg} . . . . –65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			SN54ABTE16245			SN74ABTE16245			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}, V_{CC}BIAS	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	$\overline{OE}$	2			2			V
		Except $\overline{OE}$	1.6			1.6			
V_{IL}	Low-level input voltage	$\overline{OE}$			0.8			0.8	V
		Except $\overline{OE}$			1.4			1.4	
V_I	Input voltage		0		V_{CC}	0		V_{CC}	V
I_{OH}	High-level output current	B bus			–12			–12	mA
		A bus			–24			–60	
I_{OL}	Low-level output current	B bus			12			12	mA
		A bus			64			90	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10			10	ns/V
T_A	Operating free-air temperature		–55		125	–40		85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ABTE16245			SN74ABTE16245			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = –18 mA			–1.2			–1.2	V
V_{OH}	B port	V_{CC} = 5.5 V,	I_{OH} = –100 µA			V_{CC}–0.2			V_{CC}–0.2	V
		V_{CC} = 4.5 V	I_{OH} = –1 mA	2.4			2.4			
			I_{OH} = –12 mA	2			2			
	A port	V_{CC} = 5.5 V,	I_{OH} = –1 mA			4.5			4.5	
		V_{CC} = 4.5 V	I_{OH} = –32 mA	2.4			2.4			
			I_{OH} = –64 mA				2			
V_{OL}	B port	V_{CC} = 4.5 V	I_{OL} = 1 mA			0.4			0.4	V
			I_{OL} = 12 mA						0.8	
	A port	V_{CC} = 4.5 V	I_{OL} = 64 mA			0.55			0.55	
			I_{OL} = 90 mA						0.9	
$I_{I(hold)}$	B port	V_{CC} = 4.5 V	V_I = 0.8 V	100			100			µA
			V_I = 2 V	–100			–100			
		V_{CC} = 5.5 V,	V_I = 0 to 5.5 V			±500			±500	
I_I	Control inputs	V_{CC} = 5.5 V,	V_I = V_{CC} or GND			±1			±1	µA
	A or B ports					±20			±20	
I_{OZH}‡	A port	V_{CC} = 5.5 V,	V_O = 2.7 V			10			10	µA
I_{OZL}‡	A port	V_{CC} = 5.5 V,	V_O = 0.5 V			–10			–10	µA
I_O	A port	V_{CC} = 5.5 V,	V_O = 2.5 V	–50	–120	–180	–50		–180	mA
	B port			–25	–52	–90	–25		–90	
I_{off}		V_{CC} = 0, V_I or V_O ≤ 4.5 V, V_{CC}BIAS = 0				±100			±100	µA
I_{CC}	A or B ports	V_{CC} = 5.5 V, I_O = 0, V_I = V_{CC} or GND	Outputs high		28	36		28	36	mA
			Outputs low		38	48		38	48	
			Outputs disabled		20	32		20	32	
I_{CCD}	A or B ports	V_{CC} = 5 V, C_L = 50 pF	$\overline{OE}$ high		0.02			0.02		mA/MHz
			$\overline{OE}$ low		0.33			0.33		
C_i	Control inputs	V_I = 2.5 V or 0.5 V				10		2.5	4	pF
C_{io}	I/O ports	V_O = 2.5 V or 0.5 V				13		4.5	8	pF

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

live-insertion specifications over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS			SN54ABTE16245			SN74ABTE16245			UNIT
					MIN	TYP†	MAX	MIN	TYP†	MAX	
I_{CC} (V_{CC}BIAS)		V_{CC} = 0 to 4.5 V, V_{CC}BIAS = 4.5 V to 5.5 V, $I_{O(DC)}$ = 0				250	700		250	700	μA
		V_{CC} = 4.5 V to 5.5 V‡, V_{CC}BIAS = 4.5 V to 5.5 V, $I_{O(DC)}$ = 0					20			20	
V_O	A port	V_{CC} = 0	V_{CC}BIAS = 4.5 V to 5.5 V		1.1	1.5	1.9	1.1	1.5	1.9	V
			V_{CC}BIAS = 4.75 V to 5.25 V		1.3	1.5	1.7	1.3	1.5	1.7	
I_O	A port	V_{CC} = 0,	V_{CC}BIAS = 4.5 V	V_O = 0	–20		–100	–20		–100	μA
				V_O = 3 V	20		100	20		100	μA

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ V_{CC} – 0.5 V < V_{CC}BIAS

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V, T_A = 25°C			SN54ABTE16245		SN74ABTE16245		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	1.5	3.3	4.2	1.5	5.4	1.5	5.2	ns
t_{PHL}			1.5	3.8	4.6	1.5	5.4	1.5	5.2	
t_{PLH}	B	A	1.5	3	3.8	1.5	4.7	1.5	4.5	ns
t_{PHL}			1.5	3.1	4	1.5	4.7	1.5	4.5	
t_{PZH}	$\overline{OE}$	A	2	3.9	5.3	2	6.4	2	6.2	ns
t_{PZL}			2	4.4	5.9	2	7	2	6.8	
t_{PZH}	$\overline{OE}$	B	2	4.5	6	2	7.3	2	7.1	ns
t_{PZL}			2	5	6.4	2	7.5	2	7.3	
t_{PHZ}	$\overline{OE}$	A	2	4.9	5.9	2	7	2	6.7	ns
t_{PLZ}			2	3.7	4.6	2	5.4	2	5.1	
t_{PHZ}	$\overline{OE}$	B	2	5.2	6.2	2	7.2	2	7	ns
t_{PLZ}			2	4	5	2	5.8	2	5.5	

extended switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

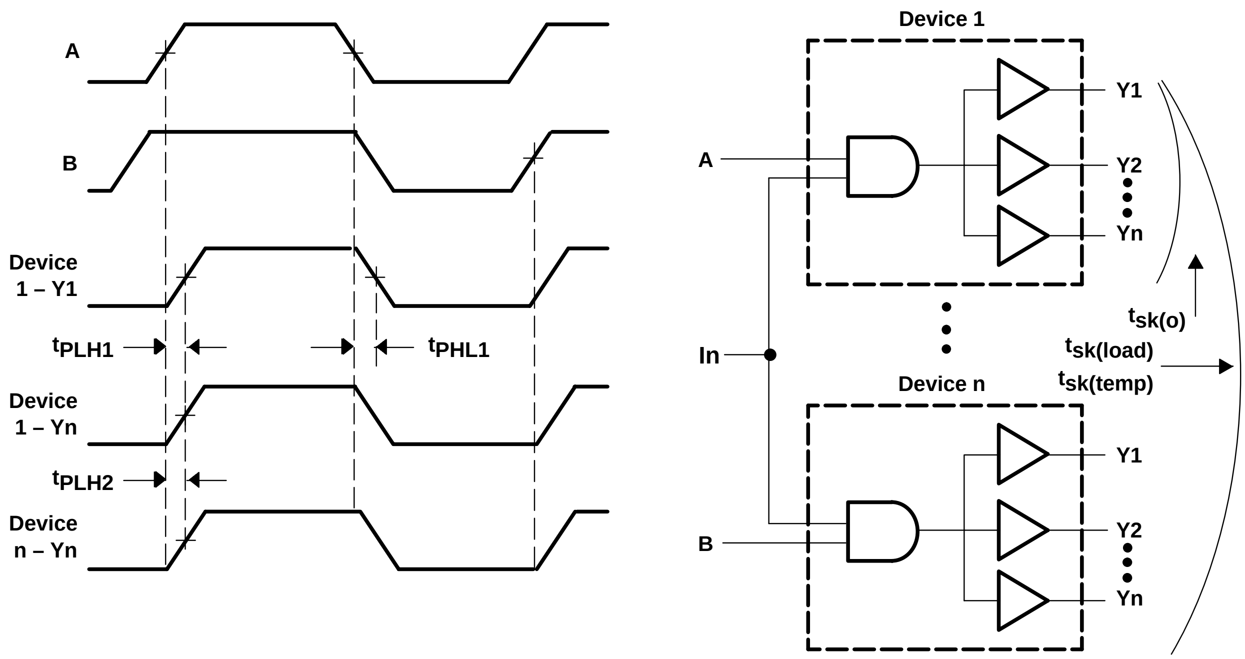
PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD	V_{CC} = 5 V, T_A = 25°C			SN54ABTE16245		SN74ABTE16245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	B	A	R_X = 13 Ω	1.5	3.2	4	1.5	5	1.5	4.8	ns
t_{PHL}				1.5	3.8	4.7	1.5	5.8	1.5	5.6	
t_{PLH}	B	A	R_X = 26 Ω	1.5	3.1	4	1.5	4.8	1.5	4.6	ns
t_{PHL}				1.5	3.5	4.4	1.5	5.2	1.5	4.9	
t_{PLH}	B	A	R_X = 56 Ω	1.5	3	3.8	1.5	4.7	1.5	4.5	ns
t_{PHL}				1.5	3.3	4.2	1.5	5.1	1.5	4.7	
$t_{sk(p)}$	B	A	R_X = Open		0.1	0.6		2		2	ns
	A	B	R_X = Open		0.4	0.8		2		2	
	B	A	R_X = 26 Ω		0.3	0.8		2		2	
$t_{sk(o)}$	B	A	R_X = Open		0.3	0.7		1.3		1.3	ns
	A	B	R_X = Open		0.7	1.1		1.3		1.3	
	B	A	R_X = 26 Ω		0.5	1		1.3		1.3	
t_t†	B	A	R_X = 26 Ω	0.5	0.8	1.5	0.5	1.5	0.5	1.5	ns
t_t‡	A	B	R_X = Open	3.5	5.5	7.3	3.5	8.1	3.5	7.9	ns

† t_t is measured between 1 V and 2 V of the output waveform.
‡ t_t is measured between 10% and 90% of the output waveform.

extended output characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	LOAD	SN54ABTE16245		SN74ABTE16245		UNIT
					MIN	MAX	MIN	MAX	
$t_{sk(temp)}$	A	B	V_{CC} = constant, ΔT_A = 20°C			3		2.5	ns
	B	A		R_X = 56 Ω		4.5		4	
$t_{sk(load)}$	B	B	V_{CC} = constant, Temperature = constant	R_X = 13, 26, or 56 Ω		4.5		4	ns

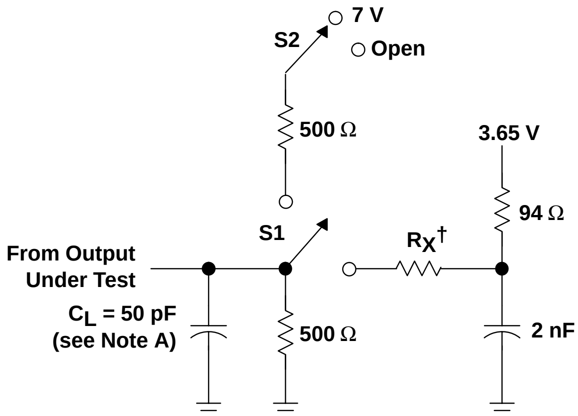
PARAMETER MEASUREMENT INFORMATION



NOTES: A. Pulse skew, $t_{sk(p)}$, is defined as the difference in propagation-delay times t_{PLH1} and t_{PHL1} on the same terminal at identical operating conditions.
B. Output skew, $t_{sk(o)}$, is defined as the difference in propagation delay of any two outputs of the same device switching in the same direction (e.g., $|t_{PLH1} – t_{PLH2}|$).
C. Temperature skew, $t_{sk(temp)}$, is the output skew of two devices, both having the same value of V_{CC} ± 1% and with package temperature differences of 20°C.
D. Load skew, $t_{sk(load)}$, is measured with R_X in Figure 2 at 13 Ω for one unit and 56 Ω for the other unit.

Figure 1. Voltage Waveforms for Extended Characteristics

PARAMETER MEASUREMENT INFORMATION

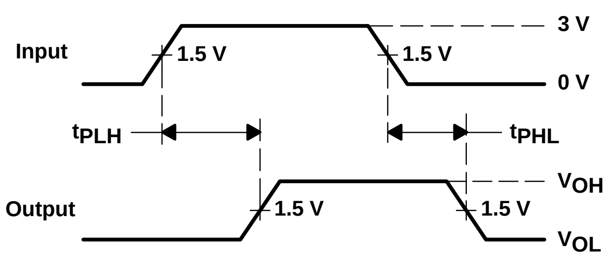


† R_X = 13, 26, or 56 Ω

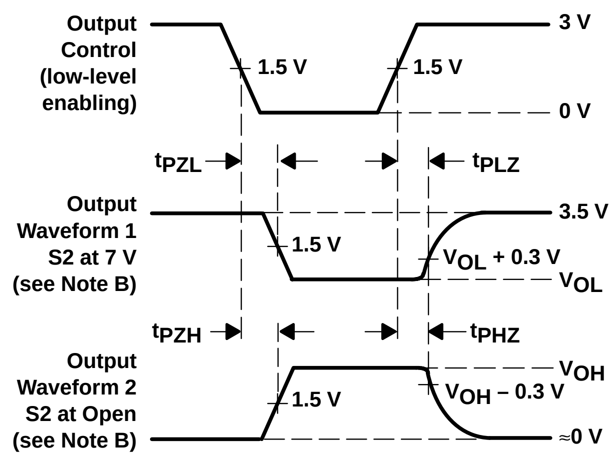
LOAD CIRCUIT FOR OUTPUTS

SWITCHING TABLE LOADS	S1	S2
t_{PLH}/t_{PHL} (A and B port)	Up	Open
t_{PLZ}/t_{PZL}	Up	7 V
t_{PHZ}/t_{PZH}	Up	Open

EXTENDED SWITCHING TABLE LOADS	S1	S2
$t_{PLH}/t_{PHL}/t_{sk}$ (A port)	Down	X
$t_{PLH}/t_{PHL}/t_{sk}$ (B port)	Up	Open
t_t (A port) (see Note E)	Down	X
t_t (B port) (see Note F)	Up	Open



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES:
A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
D. The outputs are measured one at a time with one transition per measurement.
E. t_t is measured between 1 V and 2 V of the output waveform.
F. t_t is measured between 10% and 90% of the output waveform.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
5962-9677501QXA	ACTIVE	CFP	WD	48	1	None	Call TI	Level-NC-NC-NC
SN74ABTE16245DGGR	ACTIVE	TSSOP	DGG	48	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74ABTE16245DL	ACTIVE	SSOP	DL	48	25	None	CU NIPDAU	Level-1-235C-UNLIM
SN74ABTE16245DLR	ACTIVE	SSOP	DL	48	1000	None	CU NIPDAU	Level-1-235C-UNLIM
SNJ54ABTE16245WD	ACTIVE	CFP	WD	48	1	None	Call TI	Level-NC-NC-NC

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
None: Not yet available Lead (Pb-Free).
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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